

Multilayer Ceramic Chip Capacitors

C1005NP01H150J050BA



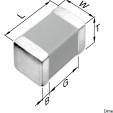






TDK item description C1005NP01H150JT****

Applications	Commercial Grade	
	Please refer to Part No. CGA2B2NP01H150J050BA for Automotive use.	
Feature	150°C High Temperature Application	
Series	C1005 [EIA 0402]	
Status	Production	



	Size	
Length(L)	1.00mm ±0.05mm	
Width(W)	0.50mm ±0.05mm	
Thickness(T)	0.50mm ±0.05mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.30mm to 0.50mm	
Recommended Land Pattern (PB)	0.35mm to 0.45mm	
Recommended Land Pattern (PC)	0.40mm to 0.60mm	

Electrical Characteristics		
Capacitance	15pF ±5%	
Rated Voltage	50VDC	
Temperature Characteristic	NP0(0±30ppm/°C)	
Q (Min.)	700	
Insulation Resistance (Min.)	10000ΜΩ	

	Other
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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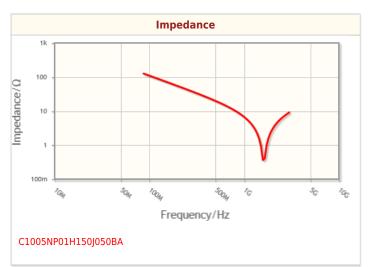


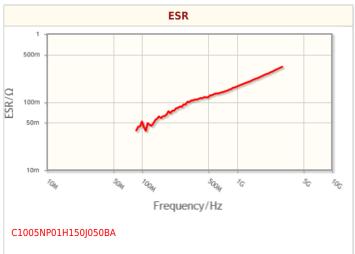


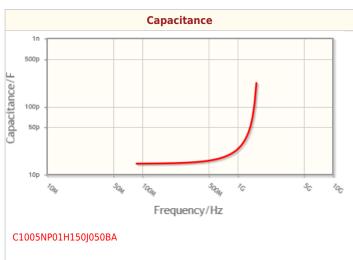


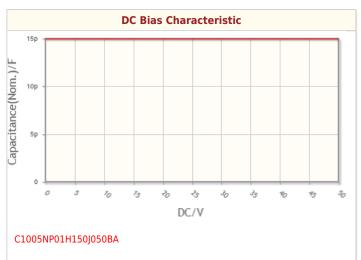


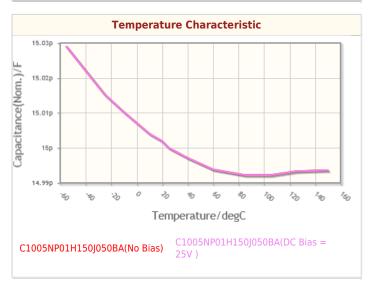
$Characteristic\ Graphs (This\ is\ reference\ data,\ and\ does\ not\ guarantee\ the\ products\ characteristics.)$











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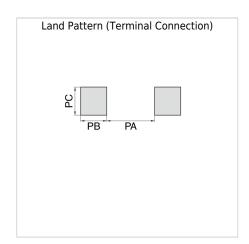








Associated Images



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